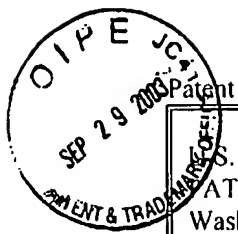


9-29-03



Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT (SEPT. - 2003)	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

U.S. PATENT DOCUMENTS

Examiner Initials	Patent Number	Issue Date	Patentee	U.S. Class	Sub-Class	Filing Date
CAT	5,148,265	09/15/92	Khandros			
CAT	5,346,861	09/13/94	Khandros			
CAT	5,347,159	09/13/94	Khandros			
CAT	5,679,977	10/21/97	Khandros			
CAT	5,683,942	11/04/97	Kata			
CAT	5,777,391	07/07/98	Nakamura			
CAT	5,905,303	05/18/99	Kata			
CAT	6,217,343	04/17/01	Okuno			

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Examiner Initials	Document Number	Publication Date	Country	Int'l Class	Sub-Class	Translation (Yes/No)
CAT	EP684644	11/29/95	EPO			
CAT	EP1009027	06/14/00	EPO			
CAT	KR 2001054744	07/02/01	Korea			English Abstract

OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

Examiner Initials	Non-Patent Document

Examiner Initials	<i>Craig 9-22</i>	Date Considered	<i>4-4-03</i>
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.			

4-25-03

Patent

Attorney Docket No. MTI-31607



U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT (04-2003)	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
	01-16-02	2813

U.S. PATENT DOCUMENTS

Examiner Initial	Patent Number	Issue Date	Patentee	U.S. Class	Sub-Class	Filing Date

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Examiner Initial	Publ. Number	Publ. Date	Applicant	U.S. Class	Sub-Class	Filing Date
CAT	US 2002/0142513	Oct. 3, 2002	Fee et al.	438	106	Apr. 19, 2001

FOREIGN PATENT OR PUBLISHED FOREIGN PATENT APPLICATION

Examiner Initial	Document Number	Publication Date	Country	Int'l Class	Sub-Class	Translation (Yes/No)

OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

Examiner Initial	Non-Patent Document

Examiner Initials <i>Craig A. Z...</i>	Date Considered <i>4-25</i>
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Patent

3-12-02

Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231 INFORMATION DISCLOSURE STATEMENT BY APPLICANT	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
	01-16-02	2812

U.S. PATENT DOCUMENTS

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CAT	A2	6,048,755	04-11-00	Jiang et al.	438	118	11-12-98
CAT	A3	6,177,723	01-23-01	Eng et al.	257	691	12-17-97
CAT	A4	6,222,265	04-24-01	Akram et al.	257	723	12-17-99
CAT	A5	6,232,666	05-15-01	Corisis et al.	257	774	12-04-98
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CAT	A7	6,265,775	07-24-01	Seyyedy	257	737	09-08-99
CAT	A8	6,291,265	09-18-01	Mess	438	107	02-09-00
CAT	A9	6,295,730	10-02-01	Akram	29	843	09-02-99

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Examiner Initial		Document Number	Publication Date	Country	Int'l Class	Sub-Class	Translation (Yes/No)
	B1						

OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

Examiner Initial		Non-Patent Document
	C1	

Examiner Initials <i>Craig A. 20</i>	Date Considered <i>4-4-5</i>
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	

2-8-05

Patent

Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT (February 8, 2005)	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

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Examiner Initials	Patent Number	Publication Date	Patentee or Applicant	U.S. Class	Sub-Class
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Examiner Initials	<i>Craig A. Z...</i>	Date Considered	4-4-5
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Examiner Initials	Patent Number	Publication Date	Patentee or Applicant	U.S. Class	Sub-Class
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CAT	2004/0212055	10/2004	Exposito et al.		
CAT	2004/0217454	11/2004	Brechignav et al.	OFFICE OF PETITIONS	

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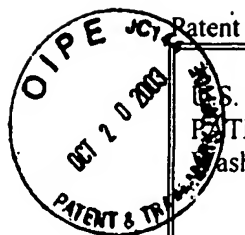
Examiner Initials	Document Number	Publication Date	Country	Name of Patentee or Applicant	Translation (Yes/No)
CAT	JP 04030456	02/1992	Japan	Yamaguchi	Yes (Abstract)
CAT	EP 0475022 A1	03/1992	EPO	Grube et al.	
CAT	EP 0997942 A2	05/2000	EPO	Horiuchi et al.	
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Examiner Initials	<i>Craig A. Jell</i>	Date Considered	4-4-5
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10-20-03



Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT (OCT 2003)	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

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CA	6,413,102	July 2, 2002	Jiang et al.	439	70	Dec.22, 1999

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Examiner Initials	Document Number	Publication Date	Country	Int'l Class	Sub- Class	Translation (Yes/No)

OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

Examiner Initials	Non-Patent Document

Examiner Initials	<i>Chay A-20</i>	Date Considered	<i>4-4-5</i>
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Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313 INFORMATION DISCLOSURE STATEMENT BY APPLICANT	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Teck Kheng Lee	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

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Examiner Initial		Document Number	Publication Date	Country	Int'l Class	Sub-Class	Translation (Yes/No)
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CAT	A2	2001077294	03-23-01	JP	H01L	25/065	Yes
CAT	A3	99/65282	12-16-99	WO	H05K	1/11	N/A

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Examiner Initial		Non-Patent Document
CAT	B1	Copy of Australian Patent Office, Search Report, 30 May 2003, 4 pages.
CAT	B2	Al-sarawi, S. et al., "A Review of 3-D Packaging Technology," <i>Components, Packaging, and Manufacturing Technology, Part B: IEEE Transactions on Advanced Packaging</i> , Vol 21, Issue 1, Feb. 1998, pp. 2-14.
CAT	B3	Andros, F. et al., "TBOA Package Technology," <i>Components, Packaging, and Manufacturing Technology, Part B: IEEE Transactions on Advanced Packaging</i> , Vol. 17, Issue 4, Nov. 1994, pp. 564-568.
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CAT	B7	Geissinger, J. et al., "Tape Based CSP Package Supports Fine Pitch Wirebonding," <i>Electronics Manufacturing Technology Symposium</i> , 2002, IEMT 2002, 27 th Annual IEEE/SEMI International, 17-18 July 2002, pp. 41-452.
CAT	B8	Hatanaka, H., "Packaging Processes Using Flip Chip Bonder and Future Directions of Technology Development," <i>Electronics Packaging Technology Conference</i> , 2002. 4 th , 10-12, Dec. 2002, pp. 434-439.
CAT	B9	Haug, R. et al., "Low-Cost Direct Chip Attach: Comparison of SMD Compatible FC Soldering with Anisotropically Conductive Adhesive FC Bonding," <i>IEEE Transactions on Electronics Packaging Manufacturing</i> , Vol. 23, No. 1, Jan 2000, pp. 12-18.

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09-09-2004

Patent

Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313 INFORMATION DISCLOSURE STATEMENT BY APPLICANT	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Tock Kheng Lee	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

Examiner Initial		Non-Patent Document
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LAT	B11	Kloeser, J. et al., "Fine Pitch Stencil Printing of Sn/Pb and Lead Free Solders for Flip Chip Technology," IEEE Transactions of CPMT - Part C, vol. 21, No. 1, 1998, pp. 41-49.
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LAT	B16	Teutsch, T. et al., "Wafer Level CSP using Low Cost Electroless Redistribution Layer," Electronic Components and Technology Conference, 2000, 2000 Proceedings, 50th, 21-24 May 2000, pp. Pages: 107-113.
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LAT	B18	Tsui, C. et al. "Pad Distribution Technology for Flip Chip Applications", 1998 Electronic Components and Technology Conference, pp. 1098-1102
LAT	B19	Xiao, G. et al., "Reliability Study and Failure Analysis of Fine Pitch Solder-Bumped Flip Chip on Low-Cost Flexible Substrate Without Using Stiffener," IEEE, 2002, Proceedings 52nd, 28-31 May 2002, pp. 112-118.

Examiner Initials	<i>Craig A. J.R.</i>	Date Considered	<i>4-4-5</i>
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09-09-2004

Patent

Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313 INFORMATION DISCLOSURE STATEMENT BY APPLICANT	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Teck Kheng Lee	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

U.S. PATENT DOCUMENTS

Examiner Initial		Document No.	Publication/ Issue Date	Patentee	U.S. Class	Sub-Class
CAT	A1	3,239,496	03/1966	Jursich		
CAT	A2	4,074,342	02/1978	Horn et al.		
CAT	A3	4,807,021	02/1989	Okumura		
CAT	A4	4,818,728	04/1989	Rai et al.		
CAT	A5	5,366,794	11/1994	Nakao		
CAT	A6	5,385,869	01/1995	Liu et al.		
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CAT	A8	5,397,921	03/1995	Kamezos		
CAT	A9	5,404,044	04/1995	Booth et al.		
CAT	A10	5,409,863	04/1995	Kamezos		
CAT	A11	5,422,205	06/1995	Inoue et al.		
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CAT	A16	5,504,277	04/1996	Danner		
CAT	A17	5,598,033	01/1997	Behlen et al.		
CAT	A18	5,646,446	07/1997	Nicewarner, Jr. et al.		
CAT	A19	5,663,530	09/1997	Schueler et al.		
CAT	A20	5,668,405	09/1997	Yamashita		
CAT	A21	5,674,785	10/1997	Akram et al.		
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Examiner Initials <i>Chang A-22</i>	Date Considered <i>4-4-5</i>
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	

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SEPT. 20, 2004

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Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313 INFORMATION DISCLOSURE STATEMENT BY APPLICANT	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
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	Teck Kheng Lee	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

Examiner Initial		Document No.	Publication/ Issue Date	Patentee	U.S. Class	Sub-Class
CAI	A35	5,834,338	11/1998	Takeda et al.		
CAI	A36	5,834,366	11/1998	Akram		
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CAI	A68	6,072,233	06/2000	Corisis et al.		
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Examiner Initials <i>CAI</i>	Date Considered <i>4-4-5</i>
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	

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	Applicant	Confirmation No.
	Teck Kheng Lee	7687
	Filing Date	Group Art Unit
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Examiner Initial	Document No.	Publication/ Issue Date	Patentee	U.S. Class	Sub-Class
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CAT	A75	6,127,736	10/2000	Akrum	
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Patent

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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313 INFORMATION DISCLOSURE STATEMENT BY APPLICANT	ATTY. DOCKET NO.	Serial No.
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Examiner Initial		Document No.	Publication/ Issue Date	Patentee	U.S. Class	Sub-Class
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